



flowPACK E2 SiC

1200 V / 11 mΩ

Topology features

- 3ph Inverter
- Low and high side Kelvin Emitter for improved switching performance
- MOSFET
- Open Emitter configuration
- Temperature sensor

Component features

- High Blocking Voltage with low drain source on state resistance
- High speed SiC-MOSFET technology
- Resistant to Latch-up

Housing features

- Base isolation: Al<sub>2</sub>O<sub>3</sub>
- Convex shaped substrate for superior thermal contact
- Compact housing
- CTI600 housing material
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

Target applications

- Charging Stations
- Elevator Drives
- Embedded Drives
- Industrial Drives
- Servo Drives

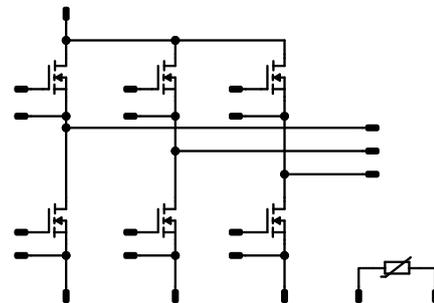
Types

- 10-EY126PB011ME-PJ19F18T

flow E2 12 mm housing



Schematic





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**10-EY126PB011ME-PJ19F18T**  
datasheet

## Maximum Ratings

$T_j = 25\text{ °C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Inverter Switch</b>				
Drain-source voltage	$V_{DS}$		1200	V
Drain current (DC current)	$I_D$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	102	A
Peak drain current	$I_{DM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	160	W
Gate-source voltage	$V_{GS}$		-4 / 15	V
		dynamic	-8 / 19	
Maximum Junction Temperature	$T_{jmax}$		175	°C

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			9,11	mm
Comparative Tracking Index	CTI		≥ 600	

\*100 % tested in production



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

#### Inverter Switch

##### Static

Drain-source on-state resistance	$r_{DS(on)}$		15		122	25 125 150	7,25	10,4 13,3 14,8	13,5 <sup>(1)</sup>	mΩ
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$			0,0336	25	1,8	2,5	3,6	V
Gate to Source Leakage Current	$I_{GSS}$		15	0		25		20	200	nA
Zero Gate Voltage Drain Current	$I_{DSS}$		0	1200		25		2	50	μA
Internal gate resistance	$r_g$							1,65		Ω
Gate charge	$Q_g$		-4/15	800	122	25		324		nC
Short-circuit input capacitance	$C_{iss}$	$f = 100$ kHz	0	1000	0	25		9636		pF
Short-circuit output capacitance	$C_{oss}$							360		
Reverse transfer capacitance	$C_{rss}$							24		
Diode forward voltage	$V_{SD}$		0		61	25		4,6		V

##### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,59		K/W
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Vincotech

10-EY126PB011ME-PJ19F18T  
datasheet

### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		
<b>Dynamic</b>										
Turn-on delay time	$t_{d(on)}$					25 125 150		21,31 20,24 20		ns
Rise time	$t_r$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$				25 125 150		16,56 14,12 13,59		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		73,96 81,65 83,76		ns
Fall time	$t_f$					25 125 150		17,51 17,85 18,28		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{rFWD}=0,688 \mu C$ $Q_{rFWD}=1,58 \mu C$ $Q_{rFWD}=1,96 \mu C$	-4/15	600	120	25 125 150		2,46 2,75 2,89		mWs
Turn-off energy (per pulse)	$E_{off}$					25 125 150		0,747 0,8 0,809		mWs
Peak recovery current	$I_{RRM}$					25 125 150		45,15 64,21 83,22		A
Reverse recovery time	$t_{rr}$					25 125 150		26,77 37,13 38,56		ns
Recovered charge	$Q_r$	$di/dt=3339 A/\mu s$ $di/dt=3979 A/\mu s$ $di/dt=4909 A/\mu s$				25 125 150		0,688 1,58 1,96		$\mu C$
Reverse recovered energy	$E_{rec}$					25 125 150		0,107 0,416 0,552		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		5060,02 9747,54 14090,2		A/ $\mu s$



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### Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GS}$ [V]	$V_{GE}$ [V]	$V_{DS}$ [V]	$V_{CE}$ [V]	$T_j$ [°C]	Min	Typ	Max	

### Thermistor

#### Static

Rated resistance	$R$					25		5		kΩ
Deviation of R100	$A_{R/R}$	$R_{100} = 499 \Omega$				100	3,2		3,3	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,3		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 1 \%$						3380		K
Vincotech Thermistor Reference									V	

<sup>(1)</sup> Value at chip level

<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.

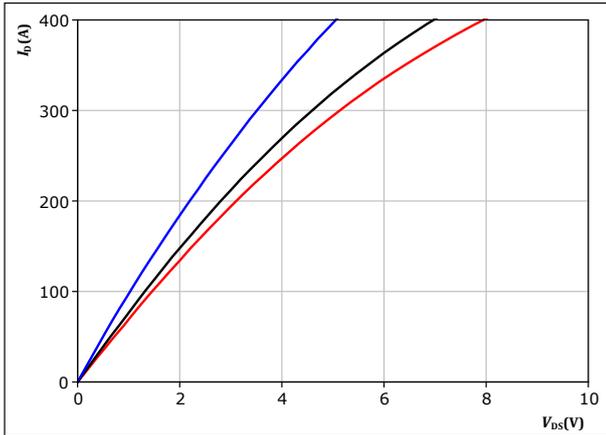


## Inverter Switch Characteristics

figure 1. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

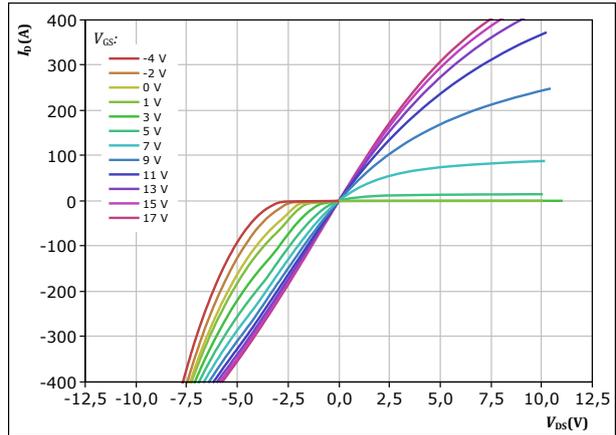


$t_p = 250 \mu s$   
 $V_{GS} = 15 V$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

figure 2. MOSFET

Typical output characteristics

$$I_D = f(V_{DS})$$

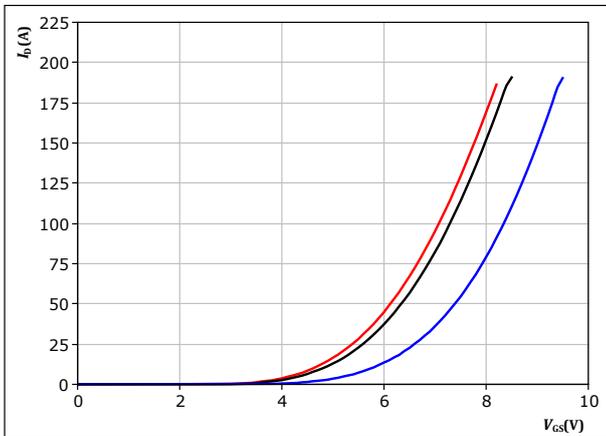


$t_p = 250 \mu s$   
 $T_j = 150 \text{ } ^\circ C$   
 $V_{GS}$  from -4 V to 17 V in steps of 2 V

figure 3. MOSFET

Typical transfer characteristics

$$I_D = f(V_{GS})$$

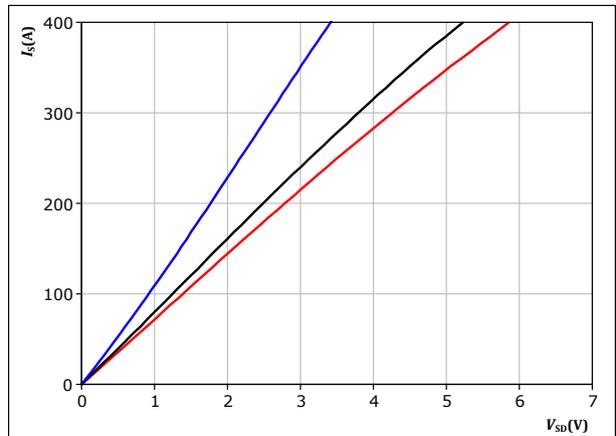


$t_p = 250 \mu s$   
 $V_{DS} = 10 V$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

figure 4. MOSFET

Typical reverse drain current characteristics

$$I_{SD} = f(V_{SD})$$



$t_p = 250 \mu s$   
 $V_{GS} = 15 V$   
 $T_j:$  — 25 °C  
— 125 °C  
— 150 °C

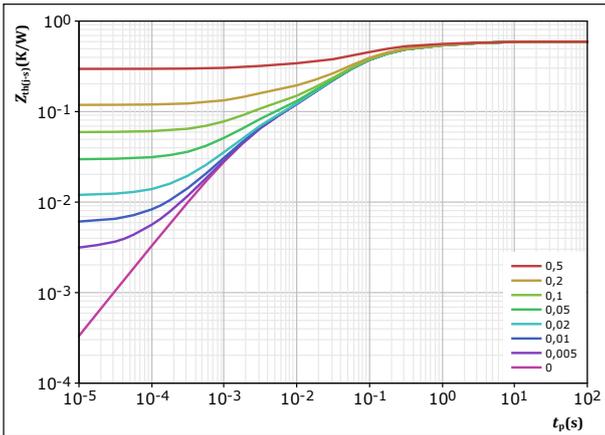


## Inverter Switch Characteristics

**figure 5.** MOSFET

Transient thermal impedance as a function of pulse width

$$Z_{th(j-c)} = f(t_p)$$



$$D = \frac{t_p}{T}$$

$$R_{th(j-c)} = 0,592 \text{ K/W}$$

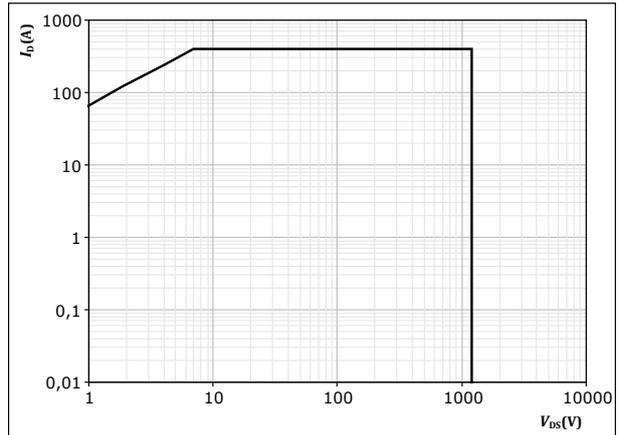
MOSFET thermal model values

R (K/W)	$\tau$ (s)
5,20E-02	3,40E+00
8,39E-02	5,42E-01
2,55E-01	9,89E-02
1,45E-01	3,19E-02
5,67E-02	2,18E-03

**figure 6.** MOSFET

Safe operating area

$$I_D = f(V_{DS})$$



D = single pulse

$$T_c = 80 \text{ } ^\circ\text{C}$$

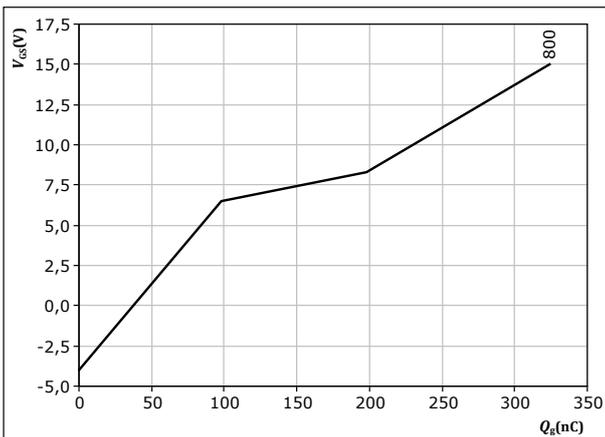
$$V_{GS} = 15 \text{ V}$$

$$T_j = T_{jmax}$$

**figure 7.** MOSFET

Gate voltage vs gate charge

$$V_{GS} = f(Q_g)$$



$$I_D = 61 \text{ A}$$

$$T_j = 25 \text{ } ^\circ\text{C}$$

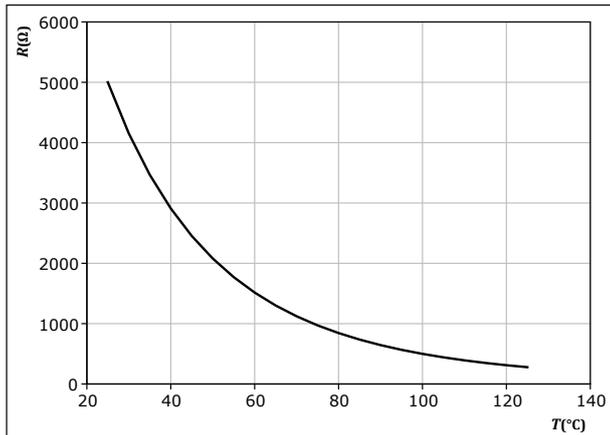


## Thermistor Characteristics

figure 8. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$

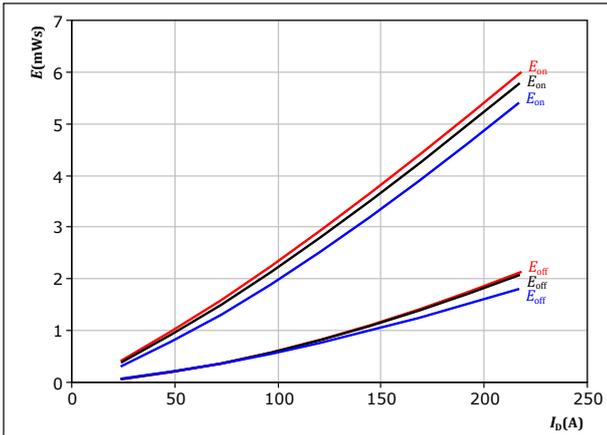




## Inverter Switching Characteristics

figure 9. MOSFET

Typical switching energy losses as a function of drain current  
 $E = f(I_D)$

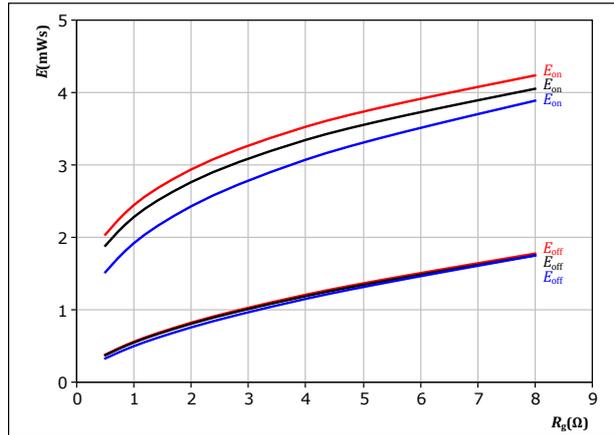


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$R_{gon} =$	2	$\Omega$		150 °C
$R_{goff} =$	2	$\Omega$		

figure 10. MOSFET

Typical switching energy losses as a function of MOSFET turn on gate resistor  
 $E = f(R_g)$

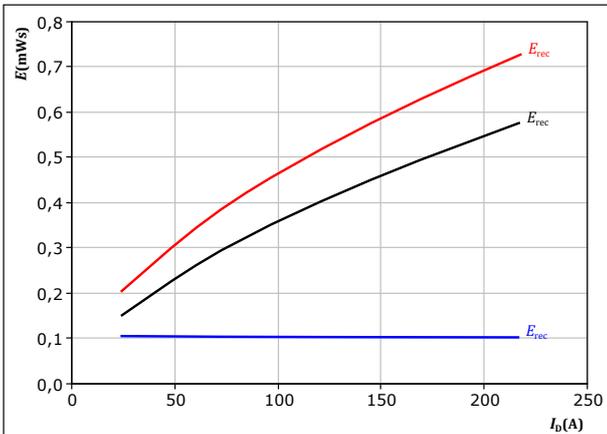


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$I_D =$	120	A		150 °C

figure 11. MOSFET

Typical reverse recovered energy loss as a function of drain current  
 $E_{rec} = f(I_D)$

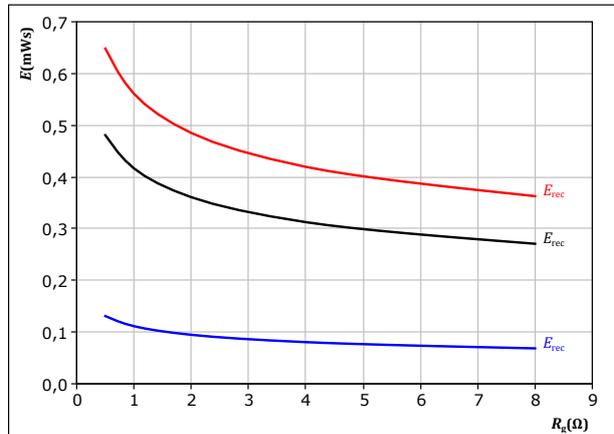


With an inductive load at

$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$R_{gon} =$	2	$\Omega$		150 °C

figure 12. MOSFET

Typical reverse recovered energy loss as a function of MOSFET turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

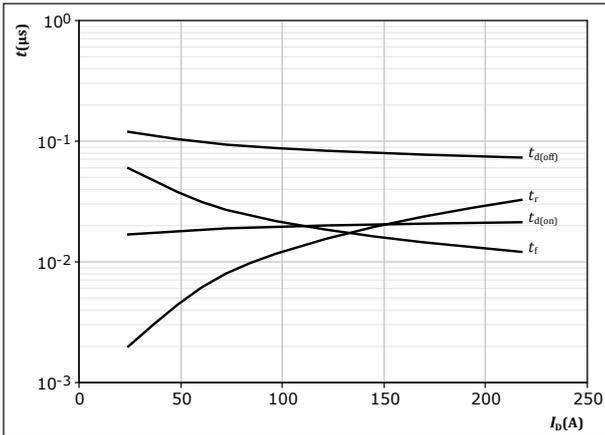
$V_{DS} =$	600	V	$T_j:$	25 °C
$V_{GS} =$	-4/15	V		125 °C
$I_D =$	120	A		150 °C



## Inverter Switching Characteristics

**figure 13.** MOSFET

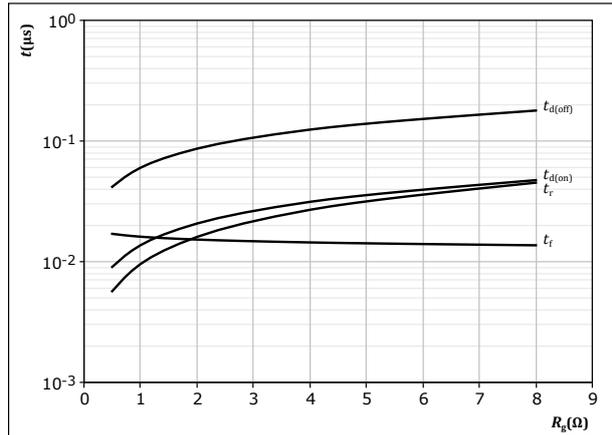
Typical switching times as a function of drain current  
 $t = f(I_D)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{gon} = 2$  Ω  
 $R_{goff} = 2$  Ω

**figure 14.** MOSFET

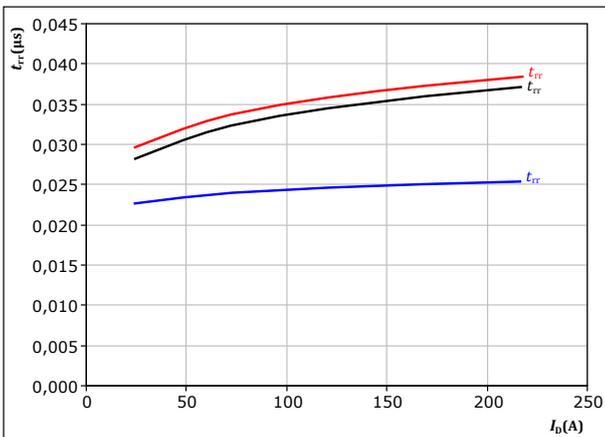
Typical switching times as a function of MOSFET turn on gate resistor  
 $t = f(R_g)$



With an inductive load at  
 $T_j = 150$  °C  
 $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 120$  A

**figure 15.** MOSFET

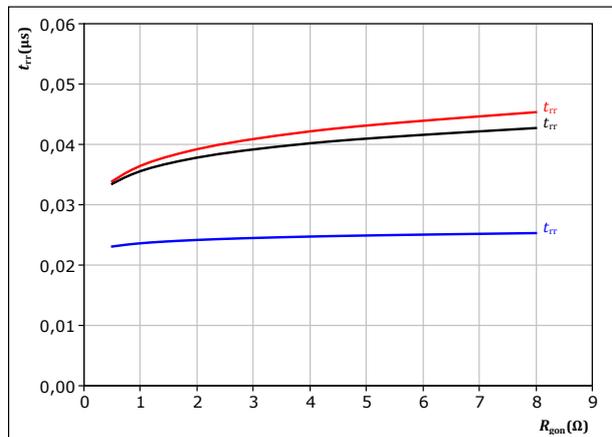
Typical reverse recovery time as a function of drain current  
 $t_{rr} = f(I_D)$



At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{gon} = 2$  Ω  
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

**figure 16.** MOSFET

Typical reverse recovery time as a function of MOSFET turn on gate resistor  
 $t_{rr} = f(R_{gon})$



At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 120$  A  
 $T_j$ : — 25 °C  
— 125 °C  
— 150 °C

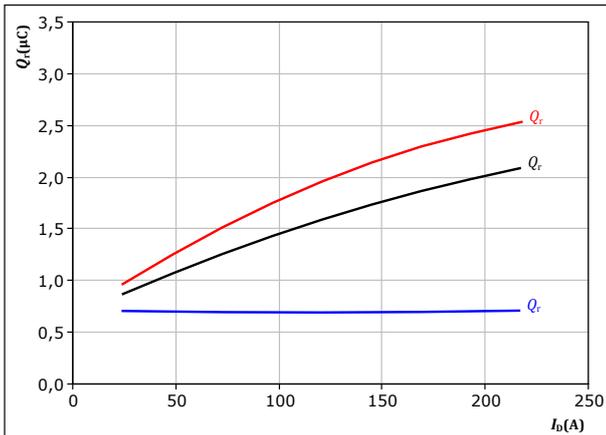


## Inverter Switching Characteristics

**figure 17.** MOSFET

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$



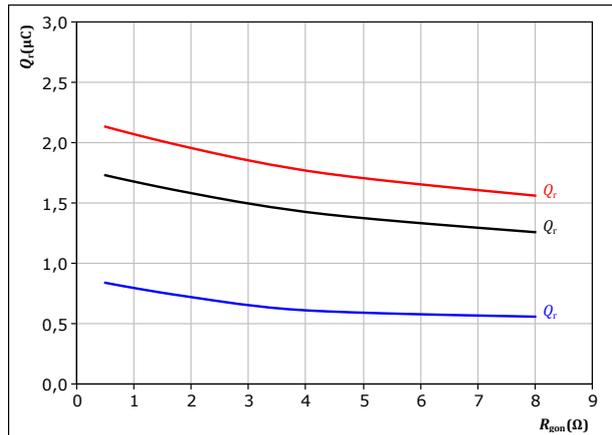
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{gon} = 2$   $\Omega$

$T_j$ : 25 °C (blue line)  
 125 °C (black line)  
 150 °C (red line)

**figure 18.** MOSFET

Typical recovered charge as a function of MOSFET turn on gate resistor

$$Q_r = f(R_{gon})$$



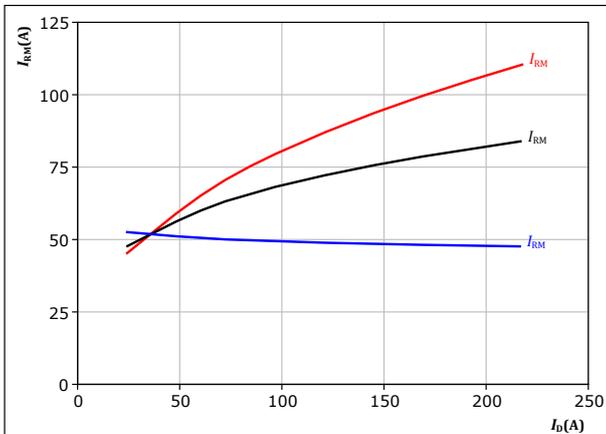
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 120$  A

$T_j$ : 25 °C (blue line)  
 125 °C (black line)  
 150 °C (red line)

**figure 19.** MOSFET

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



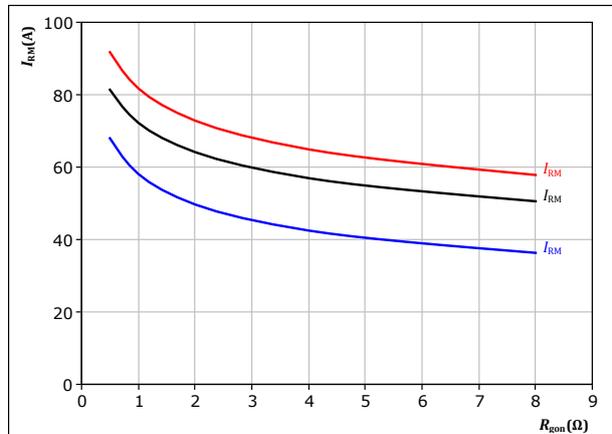
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{gon} = 2$   $\Omega$

$T_j$ : 25 °C (blue line)  
 125 °C (black line)  
 150 °C (red line)

**figure 20.** MOSFET

Typical peak reverse recovery current as a function of MOSFET turn on gate resistor

$$I_{RM} = f(R_{gon})$$



At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 120$  A

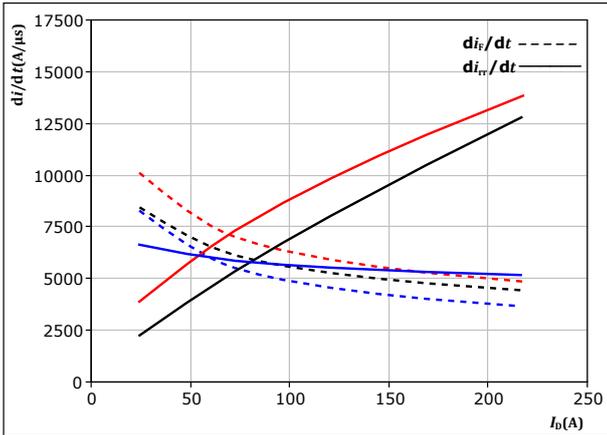
$T_j$ : 25 °C (blue line)  
 125 °C (black line)  
 150 °C (red line)



## Inverter Switching Characteristics

**figure 21.** MOSFET

Typical rate of fall of forward and reverse recovery current as a function of drain current  
 $di_f/dt, di_r/dt = f(I_D)$

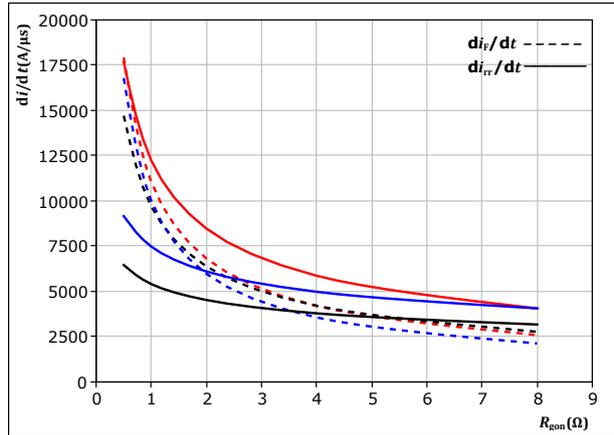


At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $R_{g(on)} = 2$   $\Omega$

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 22.** MOSFET

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_r/dt = f(R_{g(on)})$



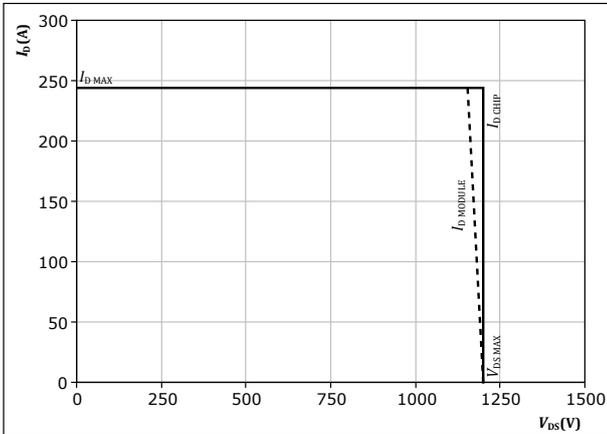
At  $V_{DS} = 600$  V  
 $V_{GS} = -4/15$  V  
 $I_D = 120$  A

$T_j$ : 25 °C (blue), 125 °C (black), 150 °C (red)

**figure 23.** MOSFET

Reverse bias safe operating area

$I_D = f(V_{DS})$



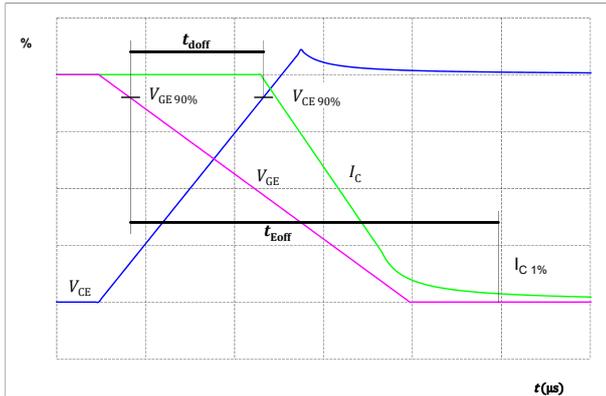
At  $T_j = 150$  °C  
 $R_{g(on)} = 2$   $\Omega$   
 $R_{g(off)} = 2$   $\Omega$



## Inverter Switching Definitions

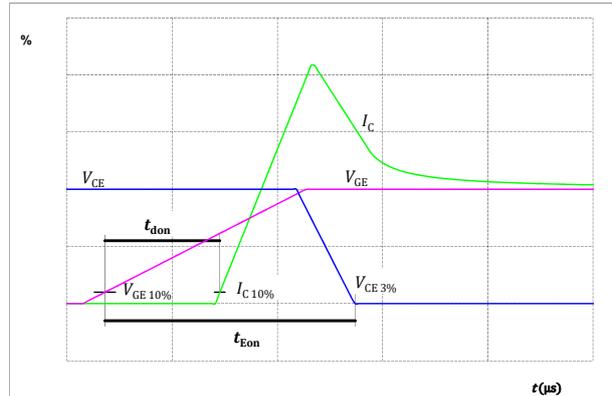
**figure 24.** MOSFET

Turn-off Switching Waveforms & definition of  $t_{doff}$   $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



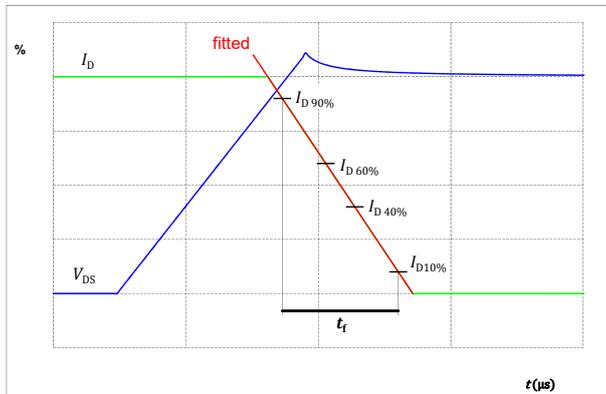
**figure 25.** MOSFET

Turn-on Switching Waveforms & definition of  $t_{don}$   $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



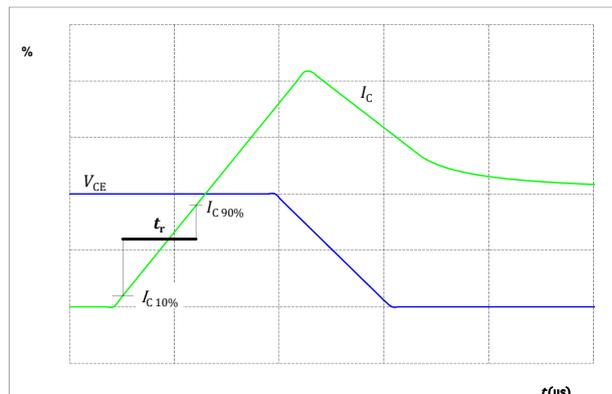
**figure 26.** MOSFET

Turn-off Switching Waveforms & definition of  $t_f$



**figure 27.** MOSFET

Turn-on Switching Waveforms & definition of  $t_r$





### Inverter Switching Definitions

figure 28. FWD

Turn-off Switching Waveforms & definition of  $t_{tr}$

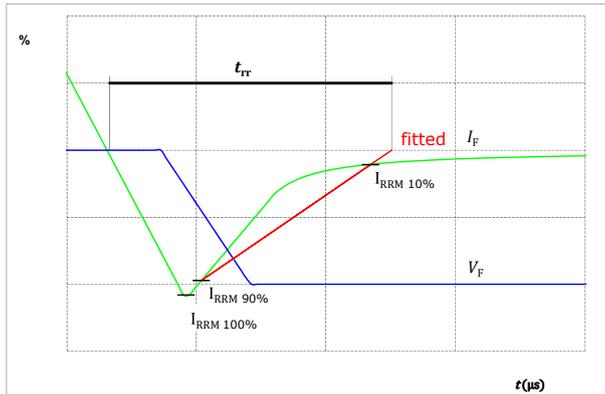


figure 29. FWD

Turn-on Switching Waveforms & definition of  $t_{Qr}$  ( $t_{Qr}$  = integrating time for  $Q_r$ )

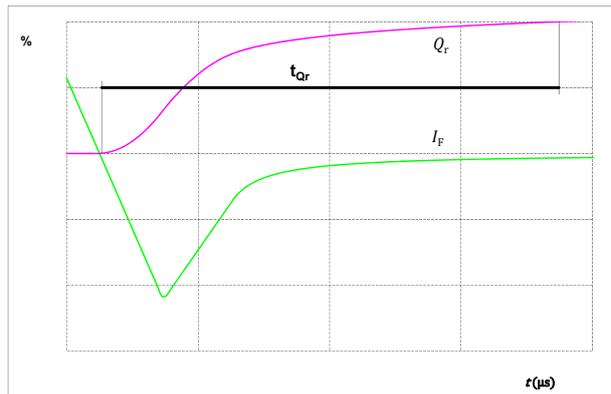
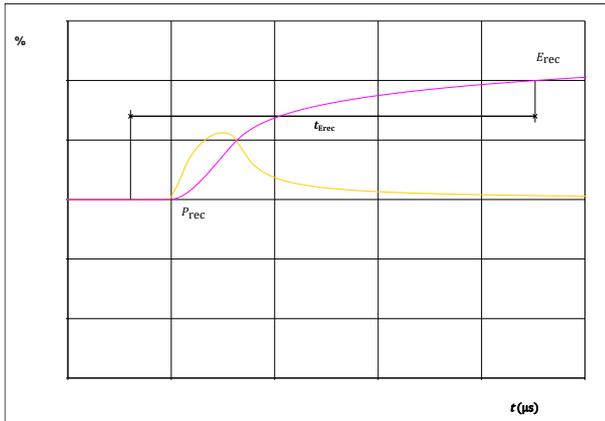


figure 30. FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$  ( $t_{Erec}$  = integrating time for  $E_{rec}$ )





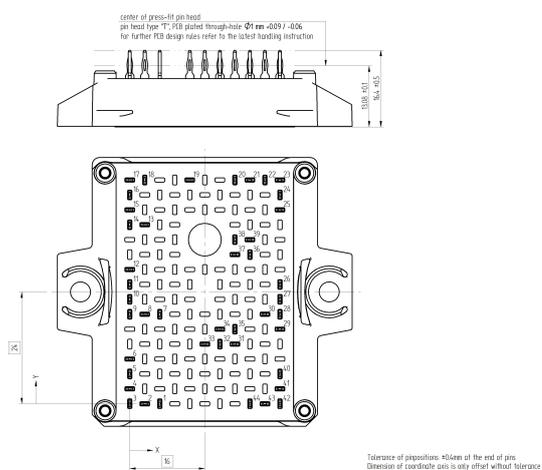
Vincotech

Ordering Code	
Version	Ordering Code
Without thermal paste	10-EY126PB011ME-PJ19F18T
With thermal paste (5,2 W/mK, PTM6000HV)	10-EY126PB011ME-PJ19F18T-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-EY126PB011ME-PJ19F18T-/3/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTVV		WWYY	UL VIN	LLLLL
Datamatrix		Type&Ver	Lot number	Serial	Date code	
	TTTTTVV	LLLLL	SSSS	WWYY		

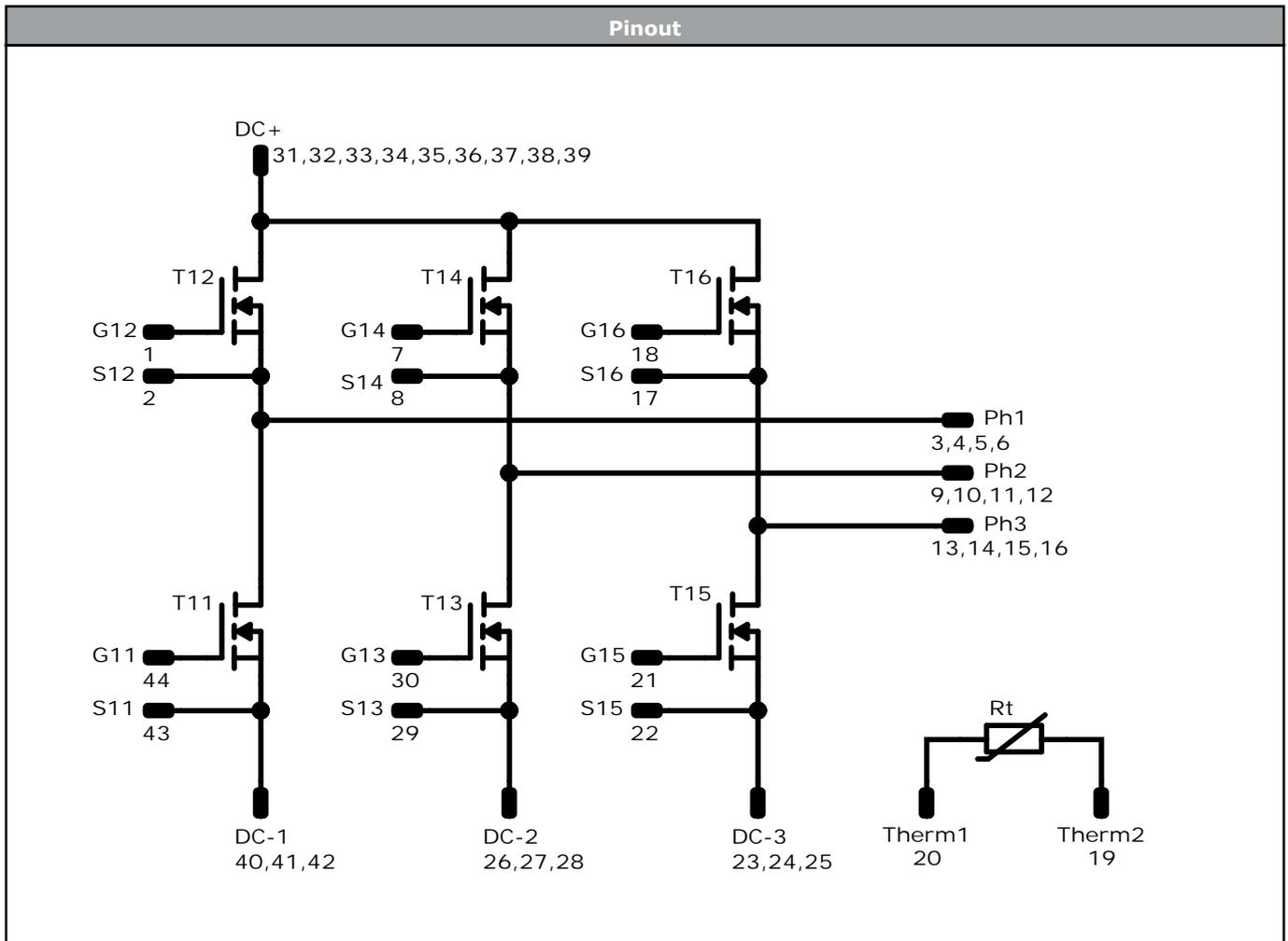
**Outline**

Pin table [mm]			
Pin	X	Y	Function
1	6,4	0	G12
2	3,2	0	S12
3	0	0	Ph1
4	0	3,2	Ph1
5	0	6,4	Ph1
6	0	9,6	Ph1
7	6,4	19,2	G14
8	3,2	19,2	S14
9	0	19,2	Ph2
10	0	22,4	Ph2
11	0	25,6	Ph2
12	0	28,8	Ph2
13	3,2	38,4	Ph3
14	0	38,4	Ph3
15	0	41,6	Ph3
16	0	44,8	Ph3
17	0	48	S16
18	3,2	48	G16
19	12,8	48	Therm2
20	22,4	48	Therm1
21	25,6	48	G15
22	28,8	48	S15
23	32	48	DC-3
24	32	44,8	DC-3
25	32	41,6	DC-3
26	32	25,6	DC-2
27	32	22,4	DC-2
28	32	19,2	DC-2
29	32	16	S13
30	28,8	19,2	G13
31	22,4	12,8	DC+
32	19,2	12,8	DC+
33	16	12,8	DC+
34	19,2	16	DC+
35	22,4	16	DC+
36	25,6	32	DC+
37	22,4	32	DC+
38	22,4	35,2	DC+
39	25,6	35,2	DC+
40	32	6,4	DC-1
41	32	3,2	DC-1
42	32	0	DC-1
43	28,8	0	S11
44	25,6	0	G11





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Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	MOSFET	1200 V	10,5 mΩ	Inverter Switch	
Rt	Thermistor			Thermistor	



Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow</i> E2 packages see vincotech.com website.

Package data
Package data for <i>flow</i> E2 packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website. 

Document No.:	Date:	Modification:	Pages
10-EY126PB011ME-PJ19F18T-D1-14	15 Dec. 2023		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.